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PPLICATION NO	. F	ILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.	
09/820,217 03/29/2001		03/29/2001	Ha Zoong Kim	0465-0751P-SP	0465-0751P-SP 2187	
2292	7590	06/04/2003				
		KOLASCH & BI	EXAMINER			
PO BOX 7		A 22040-0747	GUERRERO, MARIA F			
I ALLS CI	iorcii, v	11 22040-0747				
				ART UNIT	PAPER NUMBER	
				2822		
				DATE MAILED: 06/04/2003		

Please find below and/or attached an Office communication concerning this application or proceeding.

• • •	Application No.	(Analia antia)					
	Application No.	Applicant(s)					
Office Action Common To	09/820,217	KIM, HA ZOONG					
Office Action Summary	Examiner	Art Unit					
	Maria Guerrero	2822					
The MAILING DATE of this communication appears on the cover sheet with the correspondence address Period for Reply							
A SHORTENED STATUTORY PERIOD FOR REPLY THE MAILING DATE OF THIS COMMUNICATION.  - Extensions of time may be available under the provisions of 37 CFR 1.13 after SIX (6) MONTHS from the mailing date of this communication.  - If the period for reply specified above is less than thirty (30) days, a reply - If NO period for reply is specified above, the maximum statutory period w - Failure to reply within the set or extended period for reply will, by statute, - Any reply received by the Office later than three months after the mailing earned patent term adjustment. See 37 CFR 1.704(b).  Status	86(a). In no event, however, may a reply be within the statutory minimum of thirty (30) or ill apply and will expire SIX (6) MONTHS frocause the application to become ABANDO	timely filed days will be considered timely, om the mailing date of this communication, NED (35 U.S.C. § 133).					
1) Responsive to communication(s) filed on 27 N	<u> 1arch 2003</u> .						
2a) ☐ This action is <b>FINAL</b> . 2b) ☑ Thi	s action is non-final.						
3) Since this application is in condition for allowance except for formal matters, prosecution as to the merits is							
closed in accordance with the practice under <i>I</i> <b>Disposition of Claims</b>	Ex parte Quayle, 1935 C.D. 11	, 453 O.G. 213.					
4)⊠ Claim(s) <u>5-8 and 10-12</u> is/are pending in the application.							
4a) Of the above claim(s) is/are withdrawn from consideration.							
5) Claim(s) is/are allowed.							
6)⊠ Claim(s) <u>5-8 and 10-12</u> is/are rejected.		4					
7) Claim(s) is/are objected to.		\					
8) Claim(s) are subject to restriction and/or election requirement.							
Application Papers							
9) The specification is objected to by the Examiner.							
10) The drawing(s) filed on is/are: a) accepted or b) objected to by the Examiner.							
Applicant may not request that any objection to the drawing(s) be held in abeyance. See 37 CFR 1.85(a).							
11) The proposed drawing correction filed on is: a) approved b) disapproved by the Examiner.  If approved, corrected drawings are required in reply to this Office action.							
12) The oath or declaration is objected to by the Examiner.							
Priority under 35 U.S.C. §§ 119 and 120							
13) Acknowledgment is made of a claim for foreign priority under 35 U.S.C. § 119(a)-(d) or (f).							
a) ☐ All b) ☐ Some * c) ☐ None of:							
1. Certified copies of the priority documents	s have been received.	$\dot{f}$					
2. Certified copies of the priority documents have been received in Application No							
3. Copies of the certified copies of the priority documents have been received in this National Stage application from the International Bureau (PCT Rule 17.2(a)).  * See the attached detailed Office action for a list of the certified copies not received.							
14) Acknowledgment is made of a claim for domestic priority under 35 U.S.C. § 119(e) (to a provisional application).							
a) The translation of the foreign language provisional application has been received.  15) Acknowledgment is made of a claim for domestic priority under 35 U.S.C. §§ 120 and/or 121.							
Attachment(s)							
1) Notice of References Cited (PTO-892) 2) Notice of Draftsperson's Patent Drawing Review (PTO-948) 3) Information Disclosure Statement(s) (PTO-1449) Paper No(s)	5) Notice of Informa	ary (PTO-413) Paper No(s) al Patent Application (PTO-152)					

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#### **DETAILED ACTION**

1. This Office Action is in response to the Request for continued examination and the amendment filed March 27, 2003.

Claims 1-4 and 9 are canceled.

Claims 5-8 and 10-12 are pending.

#### Continued Examination Under 37 CFR 1.114

2. A request for continued examination under 37 CFR 1.114, including the fee set forth in 37 CFR 1.17(e), was filed in this application after final rejection. Since this application is eligible for continued examination under 37 CFR 1.114, and the fee set forth in 37 CFR 1.17(e) has been timely paid, the finality of the previous Office action has been withdrawn pursuant to 37 CFR 1.114. Applicant's submission filed on March 27, 2003 has been entered.

# Claim Rejections - 35 USC § 102

The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that form the basis for the rejections under this section made in this Office action:

A person shall be entitled to a patent unless -

- (b) the invention was patented or described in a printed publication in this or a foreign country or in public use or on sale in this country, more than one year prior to the date of application for patent in the United States.
- 3. Claims 5-6, 8, and 10-11 are rejected under 35 U.S.C. 102(b) as being anticipated by Zommer (U.S. 5,698,453).

Zommer teaches preparing a semiconductor substrate of a first conductivity type, forming scribe lanes in the semiconductor substrate to define chip formation areas, and forming a deep well area in each chip formation area (Fig. 5, col. 4, lines 35-45).

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Zommer discloses the deep well area having a second conductivity type opposite the first conductivity type, and forming at least one well area within the deep well area (Fig. 5, col. 4, lines 35-67, col. 6, lines 5-67). Zommer shows the first conductivity type being N-type and the second conductivity type being P-type (Fig. 5, Abstract). Zommer teaches the scribe lanes containing only an unetched portion of the semiconductor substrate (Fig. 5).

# Claim Rejections - 35 USC § 103

The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:

- (a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.
- 4. Claims 5-7 and 12 are rejected under 35 U.S.C. 103(a) as being unpatentable over Hirabayashi (U.S. 5,614,445) in view of Kim et al. (U.S. 6,159,826).

Hirabayashi teaches preparing a semiconductor substrate of a first conductivity type, forming scribe lanes in the semiconductor substrate to define chip formation areas, and forming a deep well area in each chip formation area (Fig. 1-4, 6-12, col. 4, lines 40-60). Hirabayashi discloses the deep well area having a second conductivity type opposite the first conductivity type, and forming at least one well area within the deep well area (col. 5, lines 10-25, col. 6, lines 5-25). Hirabayashi shows the first conductivity type being P-type and the second conductivity type being N-type (Fig. 3-4, 11-12). In addition, Hirabayashi teaches the use of the plasma processing (col. 4, lines

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65-67). Hirabayashi teaches the scribe lanes containing only the semiconductor substrate (Fig. 1-2, col. 2, lines 60-67, col. 3, lines 1-5).

Hirabayashi does not specifically show the scribe lanes containing only an unetched portion of the semiconductor substrate. However, Kim et al. shows the scribe lanes containing only an unetched portion of the semiconductor substrate (Fig. 5-6).

Therefore, it would have been obvious to a person of ordinary skill in the art at the time of the invention to modify Hirabayashi's process by including Kim et al. teaching in order to prevent damage (Kim et al., col. 1, lines 55-67).

## Response to Arguments

5. Applicant's arguments with respect to claims 5-8 and 10-12 have been considered but are moot in view of the new ground(s) of rejection.

### Conclusion

6. Any inquiry concerning this communication or earlier communications from the examiner should be directed to Maria Guerrero whose telephone number is 703-305-0162.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Amir Zarabian can be reached on 703-308-4905. The fax phone numbers for the organization where this application or proceeding is assigned are 703-308-7722 for regular communications and 703-308-7724 for After Final communications.

Any inquiry of a general nature or relating to the status of this application or proceeding should be directed to the receptionist whose telephone number is 703-308-0956.

Maria Guerrero Patent Examiner June 2, 2003